© C	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
	IPC Web Site for Information on IPC-1752 Standard         Form Type           http://www.ipc.org/IPC-175x         Distribute				e *	<ul> <li>* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi</li> </ul>					als and Mfg Information				
Supplier Informatio	n														
Company name*			Company unique ID				Unique ID Authority					Response Date*			
onsemi											2023-00	2023-06-08			
Contact Name			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*			Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Iten	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Dat	e Version	ľ	Manufacturing Site		Weight*	UOM	Unit Type	
		NCP81106MNTXG Vr c		Vr controller with 12V drivers		2023-06-08		I	PH1		92.28	mg	Each		
Manufacturing Proc	ccess Information							-						l	
Terminal Plating / Grid Array Material Termina		erminal Base A	ase Alloy J-STD-020 MSL		L Rating	Peak Pro	Peak Process Body Temperat		ure Max Time at Peak Temp		ture Numb	er of Reflow Cyd	les		
Matte Tin (Sn) - annealed CU Allo			U Alloy	1			260 C 30		30	seconds 3					
Comments															
level 1 - maximum time a	t peak temperature d	uring sole	dering is 10-3	0 seconds											
For more information reg	garding material com	position p	olease refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	4.09	mg	Supplier	Silicon (Si)	7440-21-3		4.09	mg	
Die Attach	0.4	mg	Supplier	Epoxized Condensate Of Para- Hydrobenzaldehyde And Alkyl Phenol	129915-35-1		0.052	mg	
			Supplier	Silver (Ag)	7440-22-4		0.348	mg	
Lead Frame	36.75	mg	Supplier	Silver (Ag)	7440-22-4		0.735	mg	
			Supplier	Zinc (Zn)	7440-66-6		0.0367	mg	
			Supplier	Iron (Fe)	7439-89-6		0.8085	mg	
			Supplier	Copper (Cu)	7440-50-8		35.1698	mg	
Mold Compound-Black	47.47	mg		Epoxy Phenol Resin	proprietary data		4.2723	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		43.1977	mg	
Plating	3.01	mg	Supplier	Tin (Sn)	7440-31-5		3.01	mg	
Wire Bond - Cu	0.56	mg	Supplier	Copper (Cu)	7440-50-8		0.56	mg	